



News Release

FOR IMMEDIATE RELEASE

Entrepix Introduces Head360™ CMP Head Rebuild Services

Comprehensive rebuild solution helps semiconductor manufacturers extend CMP head life and maintain equipment performance

PHOENIX, AZ, October 26, 2026 — Entrepix, Inc., a leading provider of chemical mechanical polishing (CMP) equipment, services and process solutions, today announced Head360™ CMP Head Rebuild Services, a new offering designed to provide semiconductor manufacturers with a comprehensive solution for maintaining and rebuilding CMP heads.



Head360 combines Entrepix's CMP equipment expertise with a dedicated rebuild service focused on helping customers maximize the value of their existing CMP assets. The program gives fabs an additional option for supporting critical CMP equipment while addressing the challenges associated with aging installed equipment and ongoing maintenance requirements.

"CMP heads are critical to maintaining consistent process performance, and customers need a trusted resource that understands both the equipment and the CMP process," said Sam Curl, Business Unit Director, Entrepix. "With Head360, we're bringing that expertise together in a focused CMP Head Rebuild Services program that gives customers another way to support their installed equipment and maximize their investment."

Getting started with Head360 CMP Head Rebuild Services begins with Head2Head™ benchmarking, giving customers a straightforward way to evaluate rebuild quality and performance before making a broader commitment. Customers can submit a CMP head for evaluation and benchmarking against their current rebuild solution, providing a clear basis for comparing quality and performance. Head2Head provides a low-risk entry point to experience the Head360 approach firsthand and determine whether it is the right solution for their CMP operation.

The Head360 CMP Head Rebuild Services program complements Entrepix's broader portfolio of CMP equipment, replacement parts, equipment upgrades, field service and process expertise. By providing customers with a single source for multiple aspects of CMP equipment lifecycle support, Entrepix continues to expand its ability to support semiconductor manufacturers throughout the life of their equipment.

Learn more about Entrepix and Head360 here: <https://www.entrepix.com/cmp-head-rebuild-services>

About Entrepix Inc.

Entrepix Inc., a member of the Amtech Group, is a global leader in CMP solutions, offering parts, upgrades, process development, and wafer cleaning systems. Their high-quality replacement parts outperform OEM standards, delivering lower cost, faster delivery, and greater reliability. Entrepix also operates a state-of-the-art CMP foundry for advanced process development and wafer planarization. The company also manufactures and sells the industry's leading double-sided wafer cleaning system for semiconductor and advanced substrate applications. Headquartered in Phoenix, AZ, Entrepix supports customers across the U.S., Asia, and Europe. Learn more at www.entrepix.com.

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